

Application no.09/945,432
Amdt. dated January 26, 2004
Reply to Communication of December 22, 2003

Image
TSMC-00-523
AF
2812

January 26, 2004



TO: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

FROM: George O. Saile, Reg. No. 19,572
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Poughkeepsie, N.Y. 12603


SUBJECT: Serial #: 09/945,432
File Date: September 4, 2001
Inventor: Chung Liu
Examiner: Nguyen, Ha T
Art Unit: 2812 Title: Novel Mesh Pad...

RESPONSE TO COMMUNICATION

This is in response to the Communication dated December 22, 2003. Please amend
the above identified application for patent as follows.

CETIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States
Postal Service as first class mail in an envelope addressed to: Commissioner of Patents
and Trademarks, Washington, D.C. 20231 on February 23, 2004.

Signature 
Stephen B. Ackerman, Reg. No. 37,761

Date 2/23/04

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Amendments to the Claims are reflected in the listing of claims that begins on page 3 of this paper.

Remarks begin on page 9 of this paper.